ESD Protection Diodes

Low Capacitance ESD and Transient Voltage Protection

SD0705F10L DFN1006

SETsafe | SET fuse



Pinout and Functional Block Diagram

Applications

- Serial and Parallel Ports
- Notebooks, Desktops, Servers
- Networking and Telecom
- Cell Phone Handsets and Accessories
- Microprocessor based equipment
- Personal Digital Assistants (PDA's)
- Peripherals

Description

The SD0705F10L is designed to protect voltage sensitive component from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, portable devices, digital cameras, power supplies and many other portable applications where board space comes at a premium. Also because of its low

capacitance, it is suited for use in high frequency designs such as high speed line application.

This device has been specifically designed to protect sensitive components which are connected to data and transmission lines from overvoltage caused by ESD (electrostatic

discharge), and EFT (electrical fast transients) is designed to protect voltage sensitive component from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium. Because of its small size, it is suited for use in cellular phones, portable devices, digital cameras, power supplies and many other portable applications where board space comes at a premium. Also because of its low capacitance, it is suited for use in high frequency designs such as high speed line application. This device has been specifically designed to protect sensitive components which are connected to data and transmission lines from overvoltage caused by ESD (electrostatic

discharge), and EFT (electrical fast transients)

Features

- IEC61000-4-2 (ESD) ± 30 kV (Air), ± 30 kV (Contact)
- IEC61000-4-4 (EFT) 40 A (5 / 50 ns)
- IEC61000-4-5 (Lighting) 5 A (8 / 20 μs)
- Working Voltage 7 V
- Protects One Vcc or Data Line
- Low Capacitance
- Low Leakage Current
- Low Clamping Voltage
- Flammability Rating: UL 94 V-0
- Halogen Free and RoHS Compliant

Туре	Package	Marking	Size (mm)	Delivery Form	Delivery Quantity
SD0705F10L	DFN 1006	7BN	1.00 x 0.60 x 0.50	7" T&R	10000 PCS

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Limiting Values

(T_A = 25 °C, unless otherwise specified)

Symbol	Parameter	Conditions		Max	Unit
		IEC 61000-4-2; Contact Discharge		30	kV
V _{ESD}	Electrostatic Discharge Voltage	IEC 61000-4-2; Air Discharge		30	kV
P _{PP}	Peak Pulse Power (8 / 20 µs)	I _{PP} =20 A, t _P =8 / 20 μs		75	W
T _A	Operating Temperature Range	-	-55	125	°C
T _{stg}	Storage Temperature Range	-	-55	150	°C

Electrical Characteristics

(T_A = 25 °C, unless otherwise specified)

Symbol	Parameter	Conditions	Min	Тур.	Мах	Unit
V _{RWM}	Reverse Working Voltage	T _A = 25 °C	-	-	7.0	V
V_{BR}	Breakdown Voltage	I _R = 1 mA; T _A = 25 °C	7.5	-	-	V
I _R	Reverse Leakage Current	V _{RWM} = 5 V; T _A = 25 °C	-	-	0.2	μA
		I _{PP} = 1 A, Tp = 8 / 20 μs	-	-	10	V
Vc	Clamping Voltage	I_{PP} = 5 A, t _P = 8 / 20 µs	-	-	15	V
CJ	Junction Capacitance	V _R = 0 V, f = 1 MHz	-	16	20	pF

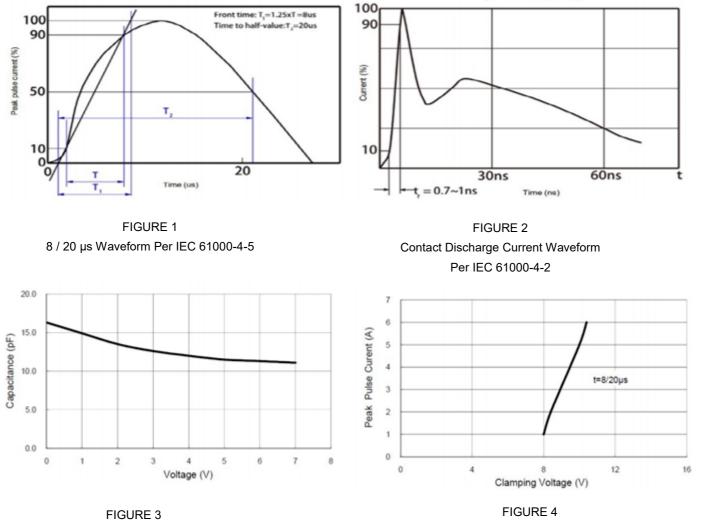
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Performance Curve for Reference

(T_A=25 °C unless otherwise noted)

ESD TVS



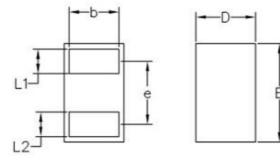
Voltage VS. Capacitance

Clamping Voltage VS. Peak Pluse Current

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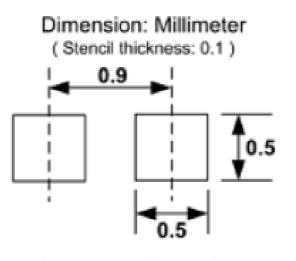
Package Dimensions - DFN1006



	Millime	ters	Inches		
Symbol	Min.	Max.	Min.	Max.	
D	0.55	0.65	0.022	0.026	
E	0.95	1.05	0.037	0.041	
L1	0.20	0.30	0.008	0.012	
L2	0.20	0.30	0.008	0.012	
A	0.45	0.55	0.018	0.022	
b	0.45	0.55	0.018	0.022	
е	0.64 BSC		0.025 BSC		

Recommended Solder Pad Footprint

(Ratings at 25 °C ambient temperature unless otherwise specified.)

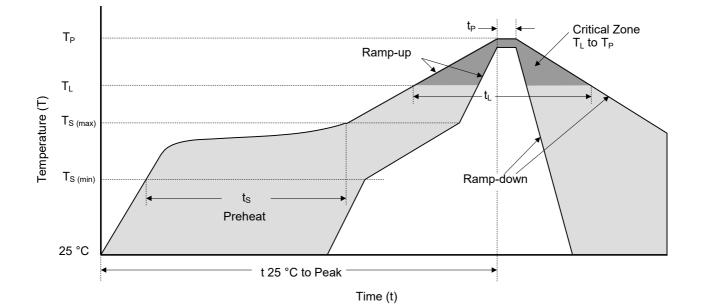


Soldering Footprint

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Soldering Parameters



Reflowing Condition

Reflow Solderin	Lead-Free Assembly		
	Temperature Min (T _{S (min)})	150 °C	
Pre-heat	Temperature Max (T _{S (max)})	200 °C	
	Time (min to max) (t _s)	60 ~ 120 seconds	
Average Ramp Up Rate (Li	Average Ramp Up Rate (Liquidus Temp (TL) to Peak		
$T_{\rm S}$ (max) to $T_{\rm L}$	T _S (max) to T _L Ramp-up Rate		
	Temperature (T _L) (Liquidus)	217 °C	
Reflow	Time (min to max) (t_L)	60 ~ 150 seconds	
Peak Temperature (T _P)		260 ^{+0/-5} °C	
Time of within 5 °C of Actu	20 ~ 40 seconds		
Ramp-do	6 °C / second max.		
Time from 25 °C to	8 Minutes max.		
Do Not Exceed		260 °C	

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Usage

- 1. TVS must be operated in the specified ambient temp.
- 2. Do not clean the TVS with strong polar solvent such as ketone, esters, benzene and halogenated hydrocarbon, to avoid damaging the encapsulating layer.
- 3. Please do not apply severe vibration, shock or pressure to TVS, to avoid element cracking.

Replacement

- 1. If TVS is visually damaged, please replace it.
- 2. TVS is a non-repairable product. For safety sake, please use equivalent TVS for replacement.

Storage

- 1. Storage Temp. Range: (-55 to 150) °C.
- 2. Do not store the TVS at the high temp., high humidity or corrosive gas environment, to avoid influencing the solder- ability of the lead wires. The product shall be used up within 1 year after receiving the goods.

Environmental Conditions

- 1. TVS should not be exposed to the open air, nor direct sunshine.
- 2. TVS should avoid rain, water vapor or other condition of high temp. and high humidity.
- 3. TVS should avoid sand dust, salt mist, or other harmful gases.

Max. Typical Capacitance of TVS

1. The typical capacitance of TVS is listed in the specifications. Designers may refer to it when designing TVS in High frequency circuit.

Installation Mechanical Stress

- 1. Do not knock TVS when installing, to avoid mechanical damage.
- 2. Please do not apply severe vibration, shock or pressure to TVS, to avoid surface resin or element cracking.

ESD TVS